



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

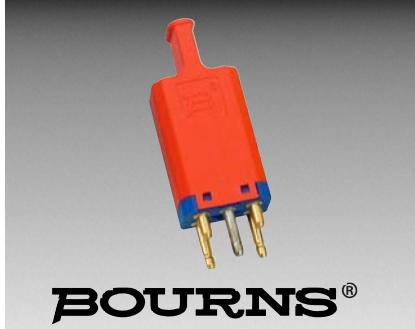


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## Features

- Patented Multi-stage protection (MSP®)
- Balanced TRIGARD®
- Patented Switch-Grade Fail-Short Device
- Quick response and high energy handling
- Ideal for high-speed networks in high exposure environments
- Listed per UL 497 (File: 53117)
- Meets test requirements of Telcordia GR 974, GR1361, SBC SR 5165 and RUS PE-80
- Telcordia Analysis report DA-1547
- Solid brass, gold-plated pins
- Test point access option
- Sealed option for harsh environments

## 2410 Series - 5-Pin Multi-Stage Protector (MSP®)

Bourns® 5-Pin Multi-Stage Protector (MSP®) is the latest generation telecommunications protector for high performance and long life in overvoltage protection of copper pair voice-band and high-speed data circuits. Bourns MSP® combines the advantages of gas tube and solid state protection while integrating three advanced technologies: a proprietary high-efficiency gas discharge tube, precision matched metal oxide varistors and a patented Switch-Grade Fail-Short mechanism. The Switch-Grade Fail-Short mechanism ensures superior thermal protection with fast acting, highly reliable response to thermal overload conditions. This combined technology provides lower capacitance, higher reliability and longer life than competitive hybrid technologies.

Bourns® 2410 can be used universally for POTS and high speed data, e.g. ISDN, ADSL, ADSL2+, VDSL, VDSL2, other xDSL protocols and high speed Ethernet. Bourns® MSP® technology provides unparalleled overvoltage protection with low loss on paired copper communications circuits. The 2410 series is the most economical, reliable and effective choice for overvoltage protection of copper pair circuits.

### Characteristics

Test Methods per UL 497, CSA C22.2, Telcordia GR 974, 1361 and SBC SR 5165.

DC Breakdown .....	300-400 V
AC Breakdown @ 60 Hz .....	300-400 V
Impulse Breakdown	
100 V/μs .....	600 V
1000 V/μs .....	650 V
Insulation Resistance @ 100 Vdc .....	>1 GΩ
Insertion Loss @ 100 MHz .....	<0.4 dB <sup>1</sup>
Return Loss @ 100 MHz .....	>14 dB <sup>1</sup>
Capacitance Tip to Ring @ 1 MHz .....	10 pF typical
Capacitance Tip or Ring to Ground @ 1 MHz .....	20 pF typical
Impulse Reset <sup>5</sup>	
52 V, 260 mA .....	<10 ms
135 V, 200 mA .....	<10 ms
150 V, 200 mA .....	<150 ms
Impulse Life Characteristics (Tip and Ring to Ground Simultaneously)	
10 to 100 A, 10/1000 μs .....	>3000 operations <sup>2</sup>
300 A, 10/1000 μs .....	>1000 operations <sup>2</sup>
500 A, 10/1000 μs .....	>1000 operations <sup>4</sup>
2,000 A, 10/250 μs .....	>100 operations <sup>2</sup>
5,000 A, 20/100 μs .....	>10 operations <sup>2</sup>
20,000 A, 8/20 μs .....	>10 operations <sup>4</sup>
AC Life Characteristics (Tip and Ring to Ground Simultaneously)	
0.5 A rms continuous .....	>30 seconds
1 A rms, 1 second, 600 ft. cable .....	>60 seconds
1 A rms, 1 second, 1 mile cable .....	>60 operations
10 A rms, 1 second .....	>5 operations
65 A rms, 11 cycles .....	>1 operation <sup>3</sup>
120 A rms, 0.1 second .....	1 operation
High Current Capability and Thermal Operation (Tip and Ring to Ground, Vented or Non-Vented Gas Tube) .....	>30 A rms, simultaneously
Storage and Operating Temperature .....	-55 to +85 °C

Telcordia analyzed for controlled (non-sealed) and uncontrolled, high-exposure (sealed) environments per GR 974 and SBC SR 5165. Telcordia Technical Analysis Report DA-1547.

### Notes:

<sup>1</sup> Tested according to Category 5 requirements

<sup>2</sup> Exceeds Telcordia (Bellcore) GR 1361

<sup>3</sup> Surpasses Telcordia GR 974

<sup>4</sup> RUS (REA) PE-80

<sup>5</sup> Network applied

Line to Line voltage is approximately 1.8 to 2 times the stated Line to Ground breakdown voltage.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

## 2410 Series - 5-Pin Multi-Stage Protector (MSP®)

**BOURNS®**

### How To Order

**Model Number Designator**

2410 - X XX - X - XXX - XX

**Module Length**

3 = Standard: 52.37 mm (2.06 in.)    7 = Special Short: 41.19 mm (1.62 in.)

**Housing Color/Circuit Type**

1 = Black/Standard	6 = Blue/Standard	10 = Yellow/Standard
3 = Red/Special	9 = Orange/Standard Service (non-Bridgelifter)	

**Pin Plating**

G = Gold Plated	N = Tin Plated
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**Protector Type**

MSP® = Multi-Stage Protector    BC = Balanced Capacitance\*

**Special Options**

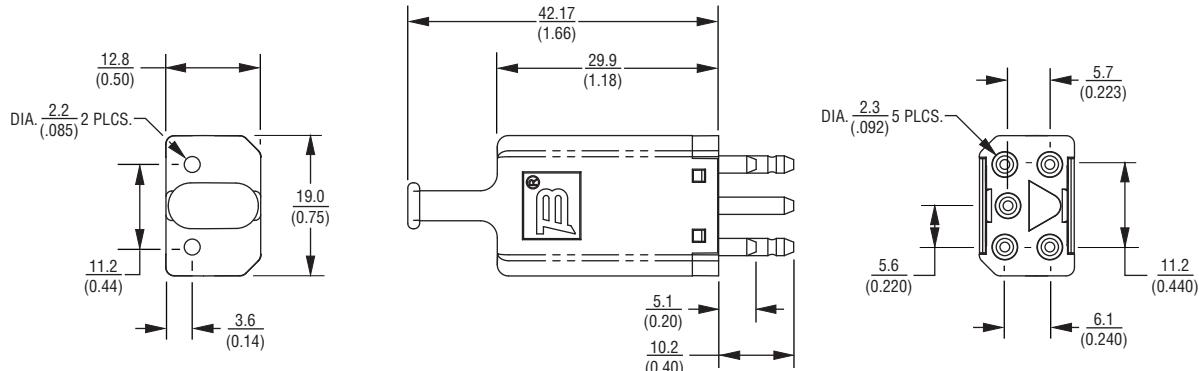
S = Sealed Case	ST = Sealed Case and Test Points**
T = Test Points**	

\*For use on DSL Systems that require balanced capacitance of  $\leq 1$  pF.

\*\*T and ST options are not available on 2410-7x short module.

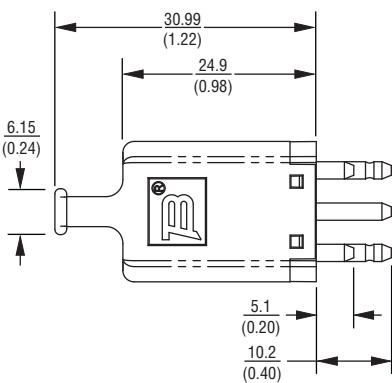
### Product Dimensions

**2410-3 MODULE**



**2410-7 MODULE**

DIMENSIONS: MM  
(INCHES)



REV. O 04/15

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